FAIRCHILD

SEMICONDUCTOR®

FCPF380N60_F152 N-Channel SuperFET[®] II MOSFET 600 V, 10.2 A, 380 mΩ

Features

- 650 V @T_J = 150°C
- Max. R_{DS(on)} = 380 mΩ
- Ultra low gate charge (typ. Q_g = 30 nC)
- Low effective output capacitance (typ. C_{oss} .eff = 95 pF)
- 100% avalanche tested

Aplications

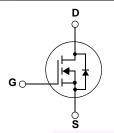
- LCD / LED / PDP TV Lighting
- Solar Inverter
- AC-DC Power Supply

GDS

Description

SuperFET[®]II MOSFET is Fairchild Semiconductor[®]'s first generation of high voltage super-junction (SJ) MOSFET family that is utilizing charge balance technology for outstanding low on-resistance and lower gate charge performance. This advanced technology is tailored to minimize conduction loss, provide superior switching performance, and withstand extreme dv/dt rate and higher avalanche energy. Consequently, SuperFET[®]II MOSFET is suitable for various AC/DC power conversion for system miniaturization and higher efficiency.





Absolute Maximum Ratings T_C = 25°C unless otherwise noted

Symbol		Parameter	FCPF380N60_F152	Unit		
V _{DSS}	Drain to Source Voltage			600	V	
V _{GSS}	Cata to Source Voltage	-DC	-DC		V	
	Gate to Source Voltage	-AC	AC (f>1HZ)			
ID	Droin Current	-Continuous ($T_C = 25^{\circ}C$)	-Continuous (T _C = 25°C)		А	
	Drain Current	-Continuous ($T_C = 100^{\circ}C$)	-Continuous (T _C = 100 ^o C)			
I _{DM}	Drain Current	- Pulsed	30.6*	А		
E _{AS}	Single Pulsed Avalanche Energy (Note 2)			211.6	mJ	
I _{AR}	Avalanche Current	(Note 1)	2.3	А		
E _{AR}	Repetitive Avalanche Energy	(Note 1)	1.06	mJ		
dv/dt	Peak Diode Recovery dv/dt	20	V/ns			
	MOSFET dv/dt	100				
P _D	Dower Dissinction	(T _C = 25°C)		31	W	
	Power Dissipation	- Derate above 25°C		0.25	W/ºC	
T _J , T _{STG}	Operating and Storage Temperature Range			-55 to +150	°C	
TL	Maximum Lead Temperature for Soldering Purpose, 1/8" from Case for 5 Seconds			300	°C	

*Drain current limited by maximum junction temperature

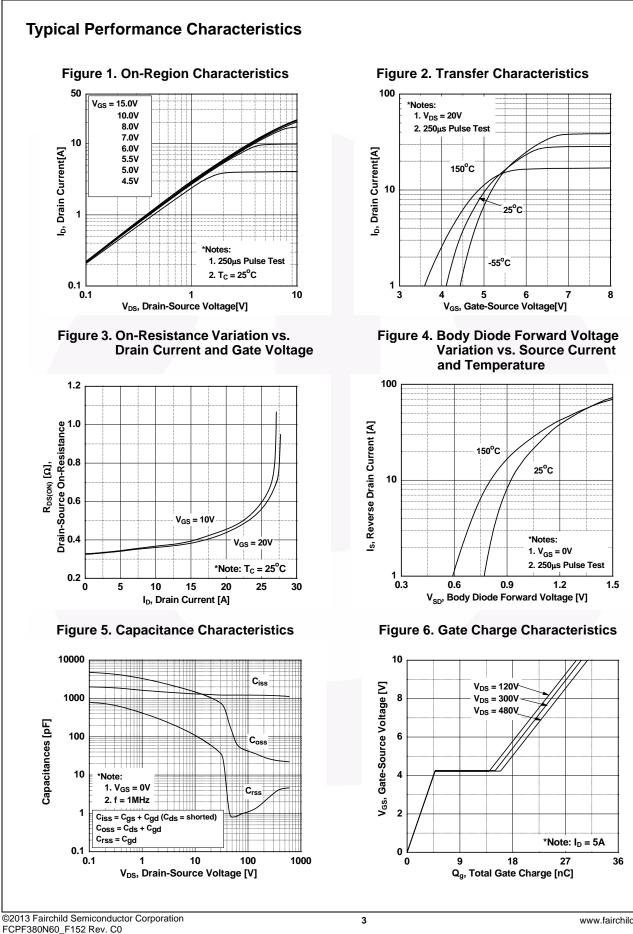
Thermal Characteristics

Symbol	Parameter	FCPF380N60_F152	Unit
$R_{ ext{ heta}JC}$	Thermal Resistance, Junction to Case	4	
$R_{\theta CS}$	Thermal Resistance, Case to Heat Sink (Typical)	0.5	°C/W
R_{\thetaJA}	Thermal Resistance, Junction to Ambient	62.5	

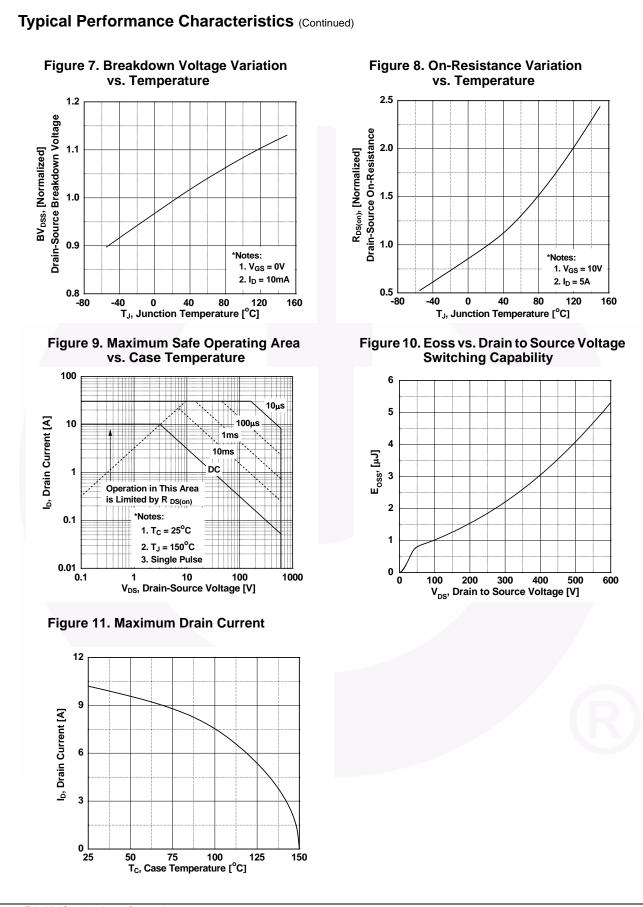
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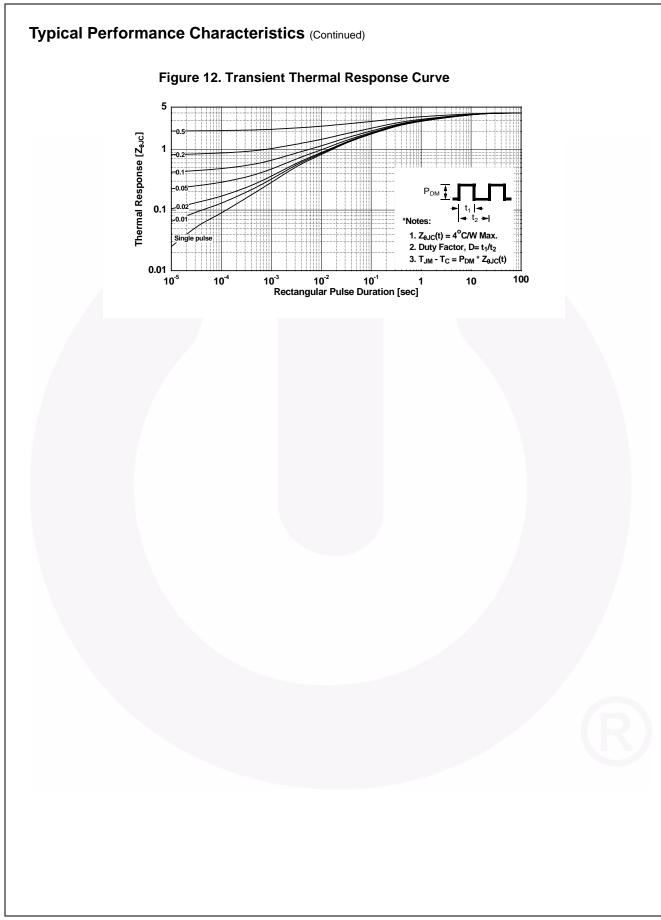
FCPF380N60_F152 — N-Channel MOSFET

Device Ma	Device Marking Device P		Pac	kage	Eco Status	Packa	ging Type	e	Quantit	у
FCPF380			TO-2	220F	Green 🧭	1	Tube		50	
or Fairchild's d	efinition of	"green" Eco Status, pleas	e visit: <u>http:</u>	://www.fai	rchildsemi.com/comp	any/green/i	ohs_gree	n.html.		
Electrica	I Chai	racteristics T _C =	25°C unle	ess otherw	vise noted					r
Symbol		Parameter			Test Conditions	5	Min.	Тур.	Max.	Unit
Off Charac	teristic	s								
2\/	Drain t			$V_{GS} = 0V, I_D = 10mA, T_J = 25^{\circ}C$ $V_{GS} = 0V, I_D = 10mA, T_J = 150^{\circ}C$			600	-	-	V
BV _{DSS}	SS Drain to Source Breakdown Voltage		Ullage				650	-	-	V
ΔBV _{DSS} ΔT _J	Coeffic	Breakdown Voltage Temperature Coefficient		I _D = 7	I0mA, Referenced to	25°C	-	0.6	-	V/ºC
3V _{DS}	Drain-Source Avalanche Breakdown Voltage		ikdown	$V_{GS} = 0V, I_{D} = 10A$			-	700	-	V
				V _{DS} :	= 480V, V _{GS} = 0V		-	-	10	
DSS	Zero G	ate Voltage Drain Curr	ent		= 480V, T _C = 125°C		-	-	10	μA
GSS	Gate to	Gate to Body Leakage Current		$V_{GS} = \pm 20V, V_{DS} = 0V$			-	-	±100	nA
On Charac	teristic	:s								
/ _{GS(th)}		hreshold Voltage	-	VGS	= V _{DS} , I _D = 250μA		2.5	-	3.5	V
R _{DS(on)}		Static Drain to Source On Resistance Forward Transconductance			= 10V, I _D = 5A	-	0.33	0.38	Ω	
ĴFS	Forwar				= 20V, I _D = 5A	-	11	-	S	
Dynamic C	haract	eristics				ł				
C _{iss}		apacitance			$V_{DS} = 25V, V_{GS} = 0V$ f = 1MHz		-	1250	1665	pF
Soss		Capacitance	_				-	905	1205	pF
S _{rss}	-	e Transfer Capacitance	Э	f = 1			-	45	60	pF
Coss	Output	t Capacitance		V _{DS} = 380V, V _{GS} = 0V, f = 1MHz			-	23	-	pF
C _{oss} eff.	Effectiv	ffective Output Capacitance			$V_{DS} = 0V$ to 480V, $V_{GS} = 0V$			95	-	pF
Q _{g(tot)}	Total G	ate Charge at 10V		$V_{DS} = 380V, I_D = 5A$ $V_{GS} = 10V$ (Note 4)		-	30	40	nC	
Q _{gs}	Gate to	Source Gate Charge				-	5	-	nC	
ຊ _{gd}	Gate to	Drain "Miller" Charge				-	10	-	nC	
ESR	Equiva	Equivalent Series Resistance		f = 1MHz			-	1	-	Ω
Switching	Charac	teristics								
d(on)	Turn-O	n Delay Time					-	14	38	ns
		n Rise Time			V _{DD} = 380V, I _D = 5A		-	7	24	ns
d(off)	Turn-O	ff Delay Time		V _{GS} = 10V, R = 4.7Ω		-	45	100	ns	
f	Turn-O	Turn-Off Fall Time			(Note 4)			6	22	ns
Drain-Sou	ce Dio	de Characteristic	S							
S	-	um Continuous Drain to		iode Forw	ard Current		-	-	10.2	Α
SM	Maximu	Maximum Pulsed Drain to Source Diode					-		30.6	А
√ _{SD}	Drain to	Drain to Source Diode Forward Voltage		V _{GS} :	$V_{GS} = 0V, I_{SD} = 5A$			-	1.2	V
rr	Revers	everse Recovery Time everse Recovery Charge		V _{GS}	$V_{GS} = 0V, I_{SD} = 5A$			240	-	ns
ל ^{גנ}	Revers			$dI_F/dt = 100A/\mu s$			-	2.7	-	μC

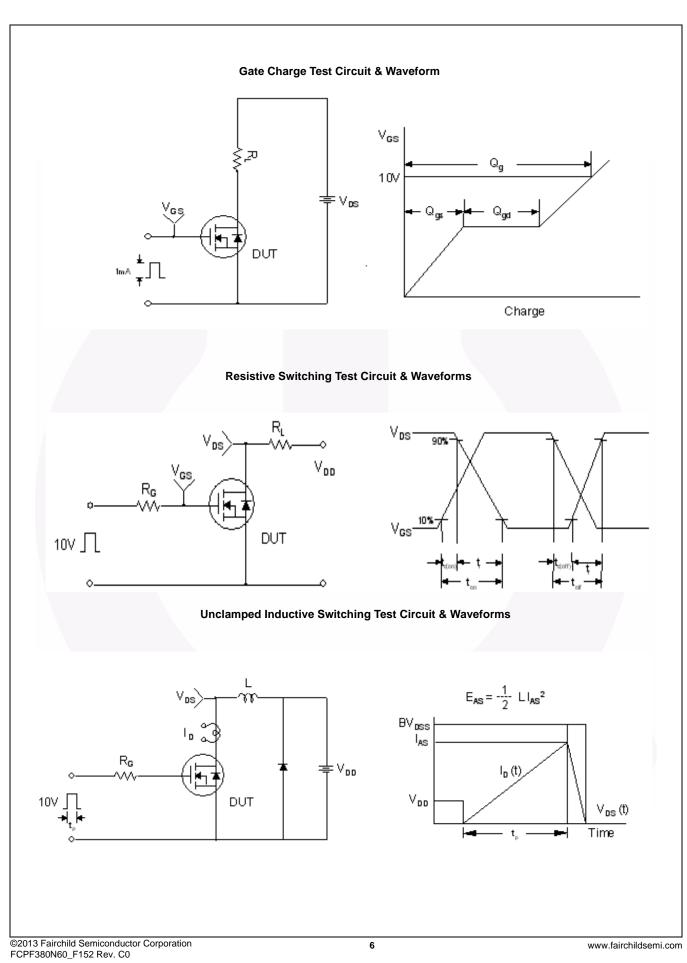


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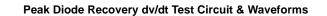


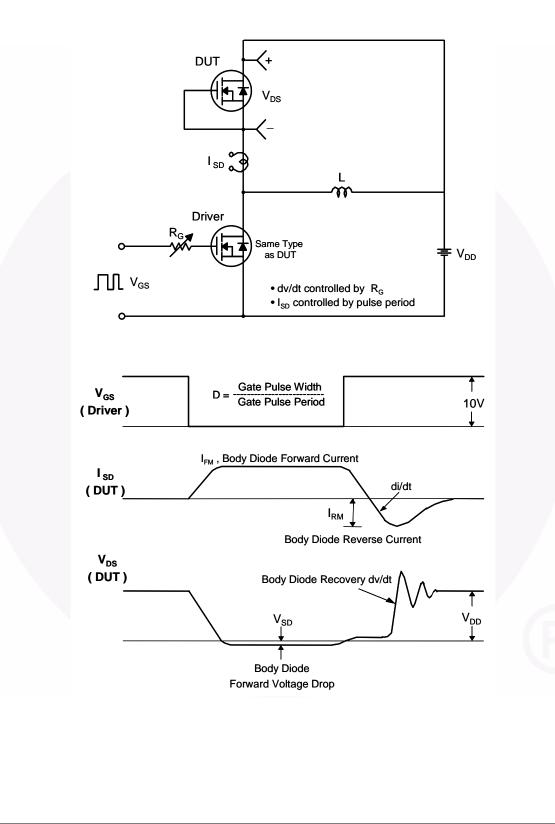


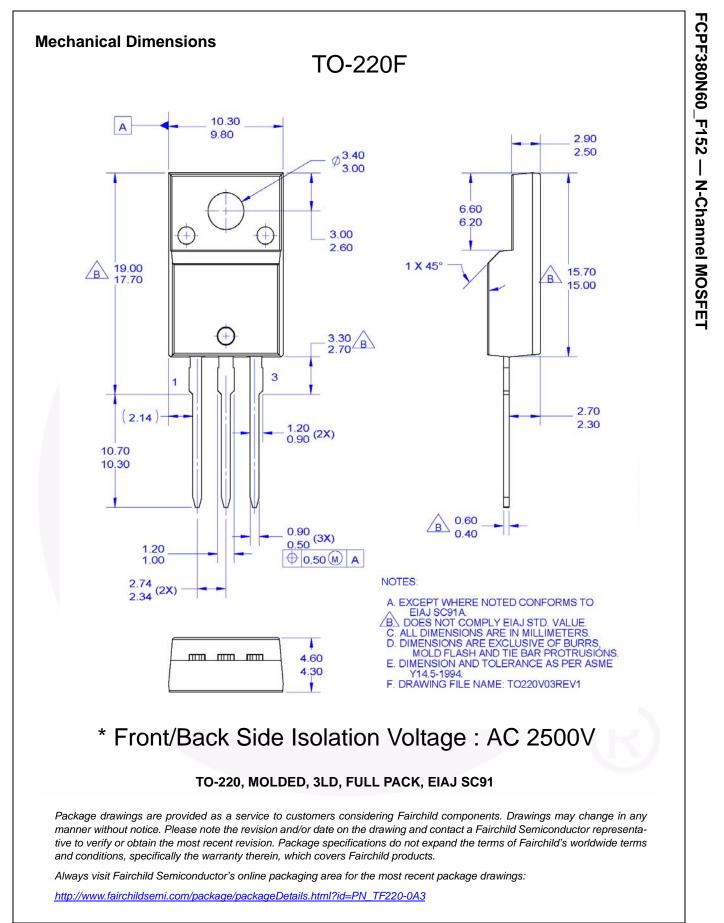
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